

Property of Lite-On Only

## **LED LAMP**

## LTL3H3TBPADS1-132A

## **DATA SHEET FOR**

**CUSTOMER: RGB SIGN** 

Part No.	Lens	Source Color
LTL3H3TBPADS1-132A	Blue Diffused	InGaN Blue

APPROVED OF PD: REV: PREPARED BY ENG: PREPARED DATE: Brian Su Feb./21, 2013 Nedphaka Α

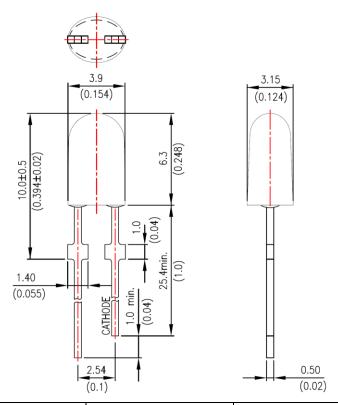


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#### **Features**

- \* High Luminous intensity output.
- \* Low power consumption.
- \* High efficiency.
- \* Wide Viewing Angle Major Axis 100° / Minor Axis 45°
- \* Versatile mounting on P.C. board or panel.
- \* I.C. Compatible/low current requirements.

#### **Package Dimensions**



Part No.	Lens	Source Color
LTL3H3TBPADS1	Blue Diffused	InGaN Blue

#### Notes:

- 1. All dimensions are in millimeters (inches).
- 2. Tolerance is  $\pm 0.25$ mm(.010") unless otherwise noted.
- 3. Protruded resin under flange is 1.0mm(.04") max.
- 4. Lead spacing is measured where the leads emerge from the package.
- 5. Specifications are subject to change without notice.

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### Absolute Maximum Ratings at TA=25℃

Parameter	Maximum Rating Uni			
Power Dissipation	110	mW		
Peak Forward Current (Duty Cycle ≤ 1/10, Pulse Width ≤ 10ms)	90	mA		
DC Forward Current	30 r			
Derating Linear From 30°C	0.45 m/			
Reverse Voltage	5 V			
Operating Temperature Range	-30°C to + 85°C			
Storage Temperature Range	-40°C to + 100°C			
Lead Soldering Temperature [2.0mm (.079") From Body]	260°C for 5 Seconds Max.			

Part No.: LTL3H3TBPADS1-132A Page: 2 of 11



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#### Electrical / Optical Characteristics at TA=25°C

Parameter	Symbol	Min.	Тур.	Max.	Unit	Test Condition
Luminous Intensity	Iv	700	900	1250	mcd	I <sub>F</sub> = 20mA Note 1,5
Viewing Angle	2 0 1/2		100 / 45		deg	Note 2 (Fig.6)
Peak Emission Wavelength	λР		464		nm	Measurement  @Peak (Fig.1)
Dominant Wavelength	$\lambda_{ m d}$	465.0	470.0	475.0	nm	Note 4
Spectral Line Half-Width	Δλ		23		nm	
Forward Voltage	$V_{\mathrm{F}}$	2.6	3.2	3.7	V	$I_F = 20 \text{mA}$
Reverse Current	$I_R$			50	$\mu$ A	$V_R = 5V$

- NOTE: 1. Luminous intensity is measured with a light sensor and filter combination that approximates the CIE eye-response curve.
  - 2.  $\theta_{1/2}$  is the off-axis angle at which the luminous intensity is half the axial luminous intensity.
  - 3. Iv classification code is marked on each packing bag.
  - 4. The dominant wavelength,  $\lambda$  d is derived from the CIE chromaticity diagram and represents the single wavelength which defines the color of the device.
  - 5. Iv guarantee must be included with  $\pm 15\%$  testing tolerance.
  - 6. Reverse voltage (VR) condition is applied for IR test only. The device is not designed for reverse operation.

Part No.: LTL3H3TBPADS1-132A Page: 3 of 11

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#### Typical Electrical / Optical Characteristics Curves

(25°C Ambient Temperature Unless Otherwise Noted)

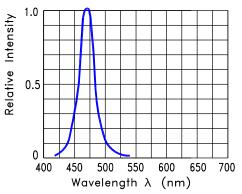


Fig.1 Relative Intensity VS. Wavelength

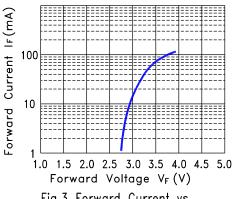


Fig.3 Forward Current vs. Forward Voltage

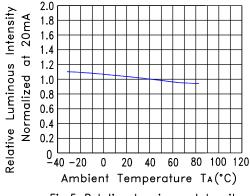


Fig.5 Relative Luminous Intensity VS. Ambient Temperature

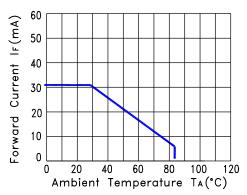


Fig.2 Forward Current Derating Curve

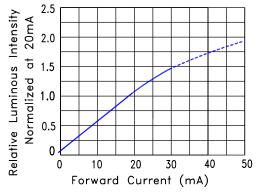


Fig.4 Relative Luminous Intensity vs. Forward Current

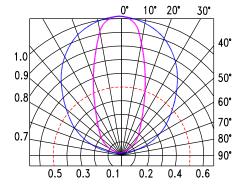


Fig.6 Spatial Distribution

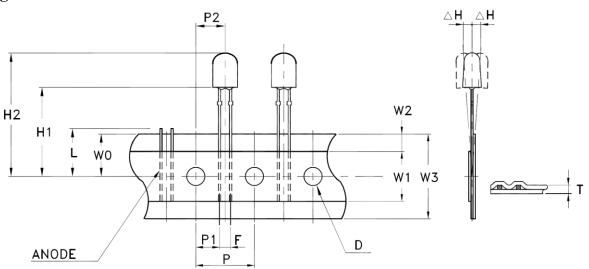
Part No.: LTL3H3TBPADS1-132A Page: of 11



#### **Features**

- \* Compatible with radial lead automatic insertion equipment.
- \* Most radial lead plastic lead lamps available packaged in tape and folding.
- \* 2.54mm (0.1") straight lead spacing available.
- \* Folding packaging simplifies handling and testing. Reel packaging is available by removing suffix "A" on option.

#### **Package Dimensions**



TAPE FEED DIRECTION

		Specification				
Item	Symbol	Minimum		Maximum		
		mm	inch	mm	inch	
Tape Feed Hole Diameter	D	3.8	0.149	4.2	0.165	
Component Lead Pitch	F	2.3	0.091	3.0	0.118	
Front to Rear Deflection	$\triangle H$	-		2.0	0.078	
Feed Hole to Bottom of Component	H1	20.0	0.787	21.0	0.827	
Feed Hole to Overall Component Height	H2	25.9	1.020	27.5	1.083	
Lead Length After Component Height	L	W0		11.0	0.433	
Feed Hole Pitch	P	12.4	0.488	13.0	0.511	
Lead Location	P1	4.4	0.173	5.8	0.228	
Center of Component Location	P2	5.05	0.198	7.65	0.301	
Total Tape Thickness	T	-		0.90	0.035	
Feed Hole Location	W0	8.5	0.334	9.75	0.384	
Adhesive Tape Position	W2	0	0	3.0	0.118	
Tape Width	W3	17.5	0.689	19.0	0.748	

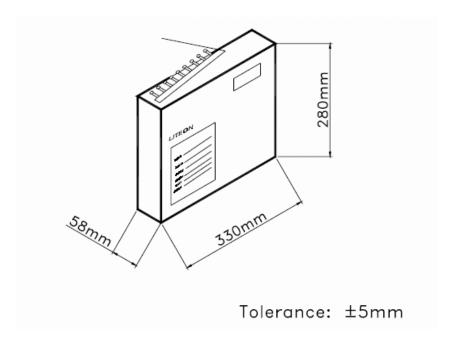
Part No.: LTL3H3TBPADS1-132A Page: 11 of



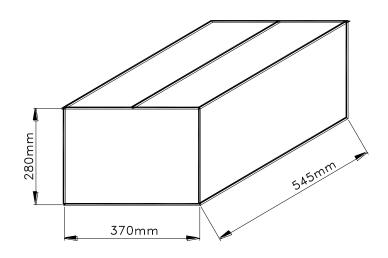
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## **Packing Spec**

### Total 2,500pcs per inner carton



10 Inner cartons per outer carton total 25,000 pcs per outer carton In every shipping lot, only the last pack will be non-full packing



Part No.: LTL3H3TBPADS1-132A Page: 6 of 11



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### **Bin Table Specification**

Luminou	s Intensity Iv(mcd)	IF@20mA
Bin Code	Min.	Max.
B1	700	950
B2	950	1250

Note: Tolerance of each bin limit is  $\pm 15\%$ 

Dominant Wavelength Unit: nm @20mA						
Bin Code	Bin Code	Bin Code				
BH1	465.0	470.0				
BH2	470.0	475.0				

Note: 1. Tolerance of each bin limit is ±1nm

2. BH1 bin is mixed with Blue dice 467.5~470.0nm (50%) & 470.0~472.5nm (50%)

Part No.: LTL3H3TBPADS1-132A Page: of 11



#### **CAUTIONS**

#### 1. Application

This LED lamp is good for application of indoor and outdoor sign, also ordinary electronic equipment.

#### 2. Storage

The storage ambient for the LEDs should not exceed 30°C temperature or 70% relative humidity.

It is recommended that LEDs out of their original packaging are used within three months.

For extended storage out of their original packaging, it is recommended that the LEDs be stored in a sealed container with appropriate desiccant or in desiccators with nitrogen ambient.

#### 3. Cleaning

Use alcohol-based cleaning solvents such as isopropyl alcohol to clean the LEDs if necessary.

#### 4. Lead Forming & Assembly

During lead forming, the leads should be bent at a point at least 3mm from the base of LED lens.

Do not use the base of the lead frame as a fulcrum during forming.

Lead forming must be done before soldering, at normal temperature.

During assembly on PCB, use minimum clinch force possible to avoid excessive mechanical stress.

#### 5. Soldering

When soldering, leave a minimum of 3mm clearance from the base of the lens to the soldering point.

Dipping the lens into the solder must be avoided.

Do not apply any external stress to the lead frame during soldering while the LED is at high temperature.

Recommended soldering conditions:

Soldering iron		Wave soldering		
Temperature	350°C Max.	Pre-heat	100°C Max.	
Soldering time	3 seconds Max.	Pre-heat time	60 seconds Max.	
	(one time only)	Solder wave	260°C Max.	
Position	No closer than 3mm	Soldering time	5 seconds Max.	
	from the base of the epoxy bulb	Dipping Position	No lower than 3mm from the	
			base of the epoxy bulb	

Note: Excessive soldering temperature and/or time might result in deformation of the LED lens or catastrophic failure of the LED. IR reflow is not suitable process for through hole type LED lamp product.

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#### 6. Drive Method

An LED is a current-operated device. In order to ensure intensity uniformity on multiple LEDs connected in parallel in an application, it is recommended that a current limiting resistor be incorporated in the drive circuit, in series with each LED as shown in Circuit A below.

## Circuit model A Circuit model B **LED**

- (A) Recommended circuit
- (B) The brightness of each LED might appear different due to the differences in the I-V characteristics of those LEDs

#### 7. ESD (Electrostatic Discharge)

Static Electricity or power surge will damage the LED.

Suggestions to prevent ESD damage:

- Use a conductive wrist band or anti- electrostatic glove when handling these LEDs
- All devices, equipment, and machinery must be properly grounded
- Work tables, storage racks, etc. should be properly grounded
- Use ion blower to neutralize the static charge which might have built up on surface of the LEDs plastic lens as a result of friction between LEDs during storage and handing

Part No.: LTL3H3TBPADS1-132A Page: of 11



#### Suggested checking list:

#### Training and Certification

- 1. Everyone working in a static-safe area is ESD-certified?
- 2. Training records kept and re-certification dates monitored?

#### Static-Safe Workstation & Work Areas

- 1. Static-safe workstation or work-areas have ESD signs?
- 2. All surfaces and objects at all static-safe workstation and within 1 ft measure less than 100V?
- 3. All ionizer activated, positioned towards the units?
- 4. Each work surface mats grounding is good?

#### Personnel Grounding

- 1. Every person (including visitors) handling ESD sensitive (ESDS) items wear wrist strap, heel strap or conductive shoes with conductive flooring?
- 2. If conductive footwear used, conductive flooring also present where operator stand or walk?
- 3. Garments, hairs or anything closer than 1 ft to ESD items measure less than 100V\*?
- 4. Every wrist strap or heel strap/conductive shoes checked daily and result recorded for all DLs?
- 5. All wrist strap or heel strap checkers calibration up to date? Note: \*50V for Blue LED.

#### **Device Handling**

- 1. Every ESDS items identified by EIA-471 labels on item or packaging?
- 2. All ESDS items completely inside properly closed static-shielding containers when not at static-safe workstation?
- 3. No static charge generators (e.g. plastics) inside shielding containers with ESDS items?
- 4. All flexible conductive and dissipative package materials inspected before reuse or recycle?

#### Others

- 1. Audit result reported to entity ESD control coordinator?
- 2. Corrective action from previous audits completed?
- 3. Are audit records complete and on file?

Page: 10 of 11 Part No.: LTL3H3TBPADS1-132A



### 8. Reliability Test

Classification	Test Item	Test Condition	Sample Size	Reference Standard
	Operation Life	Ta = 25°C IF = 30mA *Test Time= 1000hrs	45 PCS (CL=90%; LTPD=5%)	MIL-STD-750D:1026 (1995) MIL-STD-883G:1005 (2006)
	High Temperature/ High Humidity storage (THB)	Ta = 85°C RH = 85% *Test Time= 1000hrs	45 PCS (CL=90%; LTPD=5%)	MIL-STD-202G:103B (2002) JEITA ED-4701:100 103 (2001)
Endurance	Steady state Operation Life of High Humidity Heat	Ta = 85°C, RH= 85 % IF = 10mA *Test Time= 500hrs	76 PCS (CL=90%; LTPD=3%)	JESD22-A101C (2009)
Test	Low Temperature Operation Life of	Ta = -30°C IF = 30mA *Test Time= 1000hrs	45 PCS (CL=90%; LTPD=5%)	
	High Temperature Storage	Ta= 105 ± 5°C *Test Time= 1000hrs	45 PCS (CL=90%; LTPD=5%)	MIL-STD-750D:1031 (1995) MIL-STD-883G:1008 (2006) JEITA ED-4701:200 201 (2001)
	Low Temperature Storage	Ta= -55 ± 5°C *Test Time= 1000hrs	45 PCS (CL=90%; LTPD=5%)	JEITA ED-4701:200 202 (2001)
	Temperature Cycling	$100^{\circ}\text{C} \sim 25^{\circ}\text{C} \sim -40^{\circ}\text{C} \sim 25^{\circ}\text{C}$ 30mins 5mins 30mins 5mins *Test time: 200 Cycles	76 PCS (CL=90%; LTPD=3%)	MIL-STD-750D:1051 (1995) MIL-STD-883G:1010 (2006) JEITA ED-4701:100 105 (2001) JESD22-A104C (2005)
	Thermal Shock	$100 \pm 5^{\circ}\text{C} \sim -30^{\circ}\text{C} \pm 5^{\circ}\text{C}$ $15\text{mins}$ $15\text{mins}$ *Test time: 200 Cycles (<20 secs transfer)	76 PCS (CL=90%; LTPD=3%)	MIL-STD-750D:1056 (1995) MIL-STD-883G:1011 (2006) MIL-STD-202G:107G (2002) JESD22-A106B (2004)
Environmental Test	Solder Resistance	T.sol = $260 \pm 5^{\circ}$ C Dwell Time= $10\pm 1$ seconds 3mm from the base of the epoxy bulb	11 PCS (CL=90%; LTPD=18.9%)	MIL-STD-750D:2031(1995) JEITA ED-4701: 300 302 (2001
	Solderability	T. sol = 245 ± 5°C  Dwell Time= 5 ± 0.5 seconds  (Lead Free Solder, Coverage  ≥95% of the dipped surface)	11 PCS (CL=90%; LTPD=18.9%)	MIL-STD-750D:2026 (1995) MIL-STD-883G:2003 (2006) MIL-STD-202G:208H (2002) IPC/EIA J-STD-002 (2004)
	Soldering Iron	T. sol = $350 \pm 5^{\circ}$ C Dwell Time= $3.5 \pm 0.5$ seconds	11 PCS (CL=90%;LTPD =18.9%)	MIL-STD-202G:208H (2002) JEITA ED-4701:300 302 (2001)

Page: 11 Part No.: LTL3H3TBPADS1-132A of 11

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